

**Group Art Unit: Unassigned**  
**Examiner: Unassigned**

**Applicant(s):** Ming-Kun CHENG, et al.

10/750, 912

# REQUEST TO CORRECT INVENTORSHIP

),

February 17, 2004

**Sir:**

**In support of this Request, the following are submitted herewith:**

- (1) a supplemental Declaration executed by all of the inventors;
- (2) a Statement of Inventor executed by the added inventor;
- (3) a Statement of Assignee executed by the assignee of the application; and
- (4) payment of a processing fee in the amount \$130.00 in accordance with 37

CFR §1.17(i).

Please charge the fee to the Account No. 502751.

Respectfully submitted,

Signature: Ming-Kun Chang Date: January 15, 2004  
First Joint Inventor: MING-KUN CHENG

Signature: CHAO Hui Tsai Date: January 15, 2004  
Second Joint Inventor: CHAO-HUI TSAI

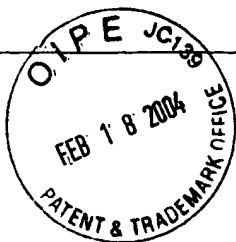
Signature: CHIEH-JEN LIN Date: January 15, 2004  
Third Joint Inventor: CHIEH-JEN LIN

Signature: Jeremy Lee Date: January 15, 2004  
Fourth Joint Inventor: JEREMY LEE

Enclosures:

- Supplemental Declaration
- Statement of Inventors
- Statement of Assignee
- Processing Fee

REQUEST FOR CORRECTION



## Declaration For Patent Application

### 專利申請宣誓書

如下所述發明者，我在此宣告：

As a below named inventor, I hereby declare that:

我的地址和國籍身份都列在底下我的姓名之後：

My residence address and citizenship are as stated below next to my name,

我相信我是原創的、第一個和單獨的發明者（若只列出一人姓名）或是原創的、第一個和共同的發明者（若列出一人以上姓名）。我要求的主題及申請的專利是關於發明\_\_\_\_\_

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled \_\_\_\_\_

**MAGNETIZED FAN AND METHOD OF  
FABRICATING THE SAME**

其說明書：

the specification of which

（註明一項）

(check one)

☐ 隨同附上

☐ is attached hereto.

☒ 於\_\_\_\_\_提出申

☒ was filed on **JANUARY 5, 2004** as

請申請順次號碼\_\_\_\_\_

Application Serial No. \_\_\_\_\_

於\_\_\_\_\_提出修正

and was amended on \_\_\_\_\_

（如適用於此。）

(if applicable)

我在此陳述我已經再次查看並明瞭以上所指的說明書的內容，包括上述的要求及修正。

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

我，按照聯邦規則法典第三十七冊第一、五六條（甲）的條文，認知我提供與審查此申請書有關的重要資料的義務。

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a).

## Chinese Language Declaration

我，按照聯邦法典第三十五冊第一一九條的條文，依據下列外國專利申請書或發明者證明申請書在此要求受益優先權，並指出任何上述要求優先權所依據的外國專利申請書或發明者證明申請書其申請日在本申請書的申請日之前。

I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

先前外國申請：

Prior Foreign Application(s)

優先權要求

Priority Claimed

(號碼) (Number)	(國名) (Country)	申請月/日/年) (Month/Day/ Year Filed)	<input type="checkbox"/> 是 Yes	<input type="checkbox"/> 否 No
(號碼) (Number)	(國名) (Country)	申請月/日/年) (Month/Day/ Year Filed)	<input type="checkbox"/> 是 Yes	<input type="checkbox"/> 否 No
(號碼) (Number)	(國名) (Country)	申請月/日/年) (Month/Day/ Year Filed)	<input type="checkbox"/> 是 Yes	<input type="checkbox"/> 否 No

我，按照聯邦法典第三十五冊第一二〇條的條文，依據下列的美國申請書要求受益。至於其中每個要求的主題未曾依聯邦法典第三十五冊第一一二條的條文在先前的申請書中透露的，而發生在先前申請書的申請日和本申請書的國家或國際申請書的申請日之間的，我，依聯邦規則法典第三十七冊第一、五六條（甲）的條文，認知提供重要資料的義務。

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, §1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(申請順次號碼)	(申請日期)	(狀況) (已專利，申請中)	(Application Serial No.)	(Filing Date)	(status) (patented, pending, abandoned)
(申請順次號碼)	(申請日期)	(狀況) (已專利，申請中)	(Application Serial No.)	(Filing Date)	(status) (patented, pending, abandoned)

我在此聲明所有就我自己知識之下所做的一切陳述均屬真實的，而且依資料和信念所做的一切陳述也相信均是真實的。還有我了解，根據聯邦法典第十八冊第一〇〇一節的規定，有企圖不實或類似的聲明時，應受罰款或監禁的，或兩項同時的處分。像這些企圖不實的聲明會危害到本申請書的合法性或危害到任何專利的批准。

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

# Chinese Language Declaration

請將所有文件寄給:

Direct All Correspondence to:

**Yi-Wen Tseng**

**4331 Stevens Battle Lane**

**Fairfax VA, 22033**

電話及傳真號碼:

Direct Telephone Calls to:

**TEL/FAX: 703-591-4934**

第一個或獨有的發明者全名	Full name of sole or first inventor
	<b>MING-KUN CHENG</b>
發明者的簽名 日期	Inventor's signature Date
	<i>Ming-Kun Cheng</i> January 15, 2004
住址:	Residence
	<b>5F, NO. 838, CHING KUO ROAD, TAOYUAN CITY, TAIWAN</b>
國籍	Citizenship
中華民國	<b>TAIWAN, ROC</b>
第二個共同發明者全名 (若有)	Full name of second joint inventor, if any
	<b>CHAO-HUI TSAI</b>
發明者的簽名 日期	Inventor's signature Date
	<i>Chao-Hui Tsai</i> January 15, 2004
住址:	Residence
	<b>5F, NO. 838, CHING KUO ROAD, TAOYUAN CITY, TAIWAN</b>
國籍	Citizenship
中華民國	<b>TAIWAN, ROC</b>
第三個共同發明者全名 (若有)	Full name of third joint inventor, if any
	<b>CHIEH-JEN LIN</b>
發明者的簽名 日期	Inventor's signature Date
	<i>Chieh-Jen Lin</i> January 15, 2004
住址:	Residence
	<b>5F, NO. 838, CHING KUO ROAD, TAOYUAN CITY, TAIWAN</b>
國籍	Citizenship
中華民國	<b>TAIWAN, ROC</b>
第四個共同發明者全名 (若有)	Full name of fourth joint inventor, if any
	<b>JEREMY LEE</b>
發明者的簽名 日期	Inventor's signature Date
	<i>Jeremy Lee</i> January 15, 2004
住址:	Residence
	<b>5F, NO. 838, CHING KUO ROAD, TAOYUAN CITY, TAIWAN</b>
國籍	Citizenship
中華民國	<b>TAIWAN, ROC</b>

第五個或獨有的發明者全名	Full name of sole or first inventor
發明者的簽名 日期	SHIH H. CHEN Inventor's signature Date
住址	Residence 5F, NO. 838, CHING KUO ROAD, TAOYUAN CITY, TAIWAN
國籍 中華民國	Citizenship TAIWAN, ROC
第六個共同發明者全名 (若有)	Full name of second joint inventor, if any
發明者的簽名 日期	Inventor's signature Date
住址	Residence
國籍 中華民國	Citizenship
第七個共同發明者全名 (若有)	Full name of third joint inventor, if any
發明者的簽名 日期	Inventor's signature Date
住址	Residence
國籍 中華民國	Citizenship
第八個共同發明者全名 (若有)	Full name of fourth joint inventor, if any
發明者的簽名 日期	Inventor's signature Date
住址	Residence
國籍 中華民國	Citizenship



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Group Art Unit: Unassigned  
Examiner: Unassigned

In Re PATENT APPLICATION Of:

**Applicant(s):** Ming-Kun CHENG, et al.

Serial No.: Unassigned 10/750,912

Filed: January 5, 2004

For: **MAGNETIZED FAN AND METHOD OF  
FABRICATING THE SAME**

**Docket No.: OP-092000391**

## STATEMENT OF INVENTOR

January 15, 2004

Commissioner for Patents  
Washington, D.C. 20231

**Sir:**

Pursuant to 37 CFR §1.48(a), each of the undersigned individuals, being added as an inventor to the above referenced application, hereby states as follows:

(1) I am an original and joint inventor of the subject matter which is claimed and for which a patent is sought in the above-referenced application; and

(2) The error in inventorship in the above-referenced application as originally filed occurred without any deceptive intention on my part.

Signed by:

Signature: \_\_\_\_\_ Date: JANUARY 15, 2004

Added Joint Inventor: Shih H. Chen

**Citizenship:** TAIWAN, ROC

Residence and Post Office Address: 5F, NO. 838, CHING KUO ROAD, TAOYUAN CITY, TAIWAN



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**Group Art Unit: Unassigned**  
**Examiner: Unassigned**

**In Re PATENT APPLICATION Of:**

**Applicant(s):** Ming-Kun CHENG, et al.

Serial No.: Unassigned 10/730/912

**Filed: January 5, 2004**

**For:        MAGNETIZED FAN AND METHOD OF  
               FABRICATING THE SAME**

**Docket No.: OP-092000391**

## STATEMENT OF ASSIGNEE

February 17, 2004

**Commissioner for Patents**  
**Washington, D.C. 20231**

**Sir:**

**Pursuant to 37 CFR §1.48(a), the undersigned hereby states as follows:**

- (1) SONICEDGE INDUSTRIES CORPORATION (SIC) is the assignee of the entire right, title and interest in the above-referenced patent application by virtue of an assignment from the inventors thereof.
- (2) SIC hereby consents to the correction of inventorship requested in the Request to Correct Inventorship submitted herewith, specifically, the inclusion of the individual Shih H. Chen as joint inventor in addition to the inventors originally named in the application; and
- (3) The undersigned is an officer of SIC duly authorized to execute this Statement of Assignee on behalf of SIC.



SONICEDGE INDUSTRIES CORPORATION

January 15, 2004  
Date

By: 

Name: SHIH H. CHEN

Title: GENERAL MANAGER

Address:

5F, NO. 838, CHING KUO ROAD, TAOYUAN  
CITY, TAIWAN, R.O.C.

Attachment:

- Assignment Document

STATEMENT OF ASSIGNEE

# ASSIGNMENT

## 讓渡書

本讓渡協議書適用的發明，其名稱爲：

(填入發明名稱) \_\_\_\_\_

\_\_\_\_\_  
\_\_\_\_\_  
\_\_\_\_\_

本協議書的讓渡人是在本協議書最後一頁簽字的發明人。

本協議書的受讓人如下：

(受讓人名字) \_\_\_\_\_

(受讓人地址) \_\_\_\_\_

\_\_\_\_\_

受讓人是：

(注明一項)

☐ 個人

☐ 合伙經營的企業

☒ 公司

(填入公司所在國家名稱)

☐ (其他) \_\_\_\_\_

\_\_\_\_\_

本協議書涉及的專利權是：

(注明一項)

☒ 本發明的專利申請案，該申請案與本讓渡書同時由讓渡人簽署。

☐ 於(申請日期) \_\_\_\_\_ 提出申請的美國專利申請號碼 \_\_\_\_\_。

☐ 根據(申請日期) \_\_\_\_\_ 提出的 PCT 國際專利申請號碼 \_\_\_\_\_

(美國專利申請號碼 \_\_\_\_\_)

(美國專利申請案。)

☐ 於(公告日期) \_\_\_\_\_ 公告的美國專利號碼 \_\_\_\_\_。

\_\_\_\_\_

WHEREAS this Assignment conveys the specified PATENT RIGHTS to the invention entitled (Invention Title) \_\_\_\_\_

**MAGNETIZED FAN AND METHOD OF FABRICATING THE SAME**

\_\_\_\_\_

AND WHEREAS the ASSIGNOR(S) of the PATENT RIGHTS by this Agreement is (or are) the inventor(s) or patent owner(s) whose signature(s) appear(s) on page 3 of this Assignment and any Supplemental Sheet(s).

The ASSIGNEE of the PATENT RIGHTS by this Agreement is:

(Name of Assignee) \_\_\_\_\_

**SONICEDGE INDUSTRIES CORPORATION**

(Address) \_\_\_\_\_

**5F, NO. 838, CHING KUO ROAD, TAOYUAN CITY, TAIWAN, R.O.C.**

\_\_\_\_\_

The ASSIGNEE is:

(check one)

☐ An Individual.

☐ A Partnership.

☒ A Corporation of **TAIWAN, R.O.C.** (specify state or country)

☐ (other) \_\_\_\_\_

\_\_\_\_\_

IT IS AGREED THAT:

The PATENT RIGHTS conveyed by this Agreement are:

(check one)

☒ a patent application for this invention, executed by the ASSIGNOR(S) concurrently with this Assignment.

☐ U.S. Patent Application Serial No. \_\_\_\_\_, filed \_\_\_\_\_.

☐ a U.S. patent application based on PCT International Application No. \_\_\_\_\_ filed on (date) \_\_\_\_\_

(U.S. patent application Serial No. \_\_\_\_\_, if known).

☐ U.S. Patent No. \_\_\_\_\_, issued \_\_\_\_\_

\_\_\_\_\_

專利權也包括上述專利和專利申請案的所有分案，再公告，續展和延長。

根據本協議書讓渡的專利權是：

(注明一項)

☐ 美國專利權

☒ 全世界的專利權，由此申請人可以要求本發明的任何美國或外國專利申請的優先日。

讓渡人考慮到，並接受了受讓人付給的 1 美元以及其他利益，特此將下述權利讓渡給受讓人及其繼任者，以及其後的受讓人：

- 本發明的全部和獨佔的權利；
- 專利權的全部權益；
- 對於任何先前的侵權案有起訴和要求賠償的權利；以及
- 按照聯邦法典 35 冊第 119 條和 120 條，或者任何其他適用的條文，依據本發明的任何先前的專利申請案，要求優先權。

對於依據本協議書讓渡的所有美國專利申請案，讓渡人於此授權和請求專利和商標局局長將全部專利證書授於受讓人，一切權益歸受讓人及其繼任者，以及其後的受讓人。

而且，讓渡人同意將其所知的有關本發明的任何資料轉達給受讓人或其他代理人，並同意在任何法律訴訟案件中作證；在所有的合法文件上簽名；簽署所有的分案，續展，替代，展期，復審和再公告申請案件；簽署一切必要的讓渡文件以使所有的專利證書均授於所述的受讓人；進行合法的宣誓；以及承擔任何必須的或合乎需要的事，

The PATENT RIGHTS also include all divisions, reissues, continuations, and extensions of the patents and patent applications identified above.

The PATENT RIGHTS assigned under this Agreement are:

(check one)

☐ U.S. patent rights only.

☒ Worldwide patent rights. In this case, the Assignee shall have the right to claim the benefit of the filing date of any U.S. or foreign patent application for this invention.

The ASSIGNOR(s), in consideration of \$1.00 paid by the ASSIGNEE, and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, hereby assign(s) the following rights to the ASSIGNEE, its successors, and assigns:

the full and exclusive right to the invention;  
the entire right, title, and interest in and to the PATENT RIGHTS, for and during the term or terms of any and all such patents when granted;  
the right to sue and recover for any past infringement of said PATENT RIGHTS; and,  
the right to claim priority under 35 USC 119, 35 USC 120, or any other applicable provisions, based on any earlier patent applications for this invention.

As to all U.S. patent applications assigned under this Agreement, the ASSIGNOR(S) hereby authorize(s) and request(s) the Commissioner of Patents and Trademarks to issue all Letters Patent to the ASSIGNEE as the assignee of the entire right, title and interest, for the sole use and enjoyment of said ASSIGNEE, its successors and assigns.

Further, the ASSIGNOR(S) agree(s) to communicate to said ASSIGNEE, or its representatives, any facts known to the ASSIGNOR(S) respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, substitute, renewal, reexamination, and reissue applications, execute all necessary assignment papers to cause any and all Letters Patent to be issued to said ASSIGNEE, made all rightful oaths

以幫助本協議書的受讓人及其繼承者，以及其後的受讓人，使之能得到和實施對所述發明的正當保護。

and generally do everything necessary or desirable to aid said ASSIGNEE, and its successors and assigns, to obtain and enforce the full extent of protection to which it is entitled for said PATENT RIGHTS.

受讓人授權本申請案所委任的律師和代理人對簽署後的本協議書進行校核，並填入序號和申請日。

The ASSIGNOR(S) authorize(s) any attorneys and agents who have a power of attorney in this application to check any appropriate boxes and to insert the Serial Number and filing date in this document after it has been executed.

茲同意：

AGREED:

CHENG MING KUN  
Name of sole or first inventor  
第一位或獨有的發明者全名

Cheng Ming Kun  
Signature 簽名

Dec 24, 2003  
Date 日期

CHAO - HUI, TSAI  
Name of second inventor, if any  
第二位發明者全名

Chao Hui Tsai  
Signature 簽名

Dec 24, 2003  
Date 日期

CHIEH - JEN, LIN  
Name of third inventor, if any  
第三位發明者全名

CHIEH-JEN LIN  
Signature 簽名

Dec 24, 2003  
Date 日期

JEREMY LEE  
Name of fourth inventor, if any  
第四位發明者全名

Jeremy Lee  
Signature 簽名

Dec 24, 2003  
Date 日期

\_\_\_\_\_  
Name of fifth inventor, if any  
第五位發明者全名

\_\_\_\_\_  
Signature 簽名

\_\_\_\_\_  
Date 日期

\_\_\_\_\_  
Name of sixth inventor, if any  
第六位發明者全名

\_\_\_\_\_  
Signature 簽名

\_\_\_\_\_  
Date 日期

\_\_\_\_\_  
Name of seventh inventor, if any  
第七位發明者全名

\_\_\_\_\_  
Signature 簽名

\_\_\_\_\_  
Date 日期

\_\_\_\_\_  
Name of eighth inventor, if any  
第八位發明者全名

\_\_\_\_\_  
Signature 簽名

\_\_\_\_\_  
Date 日期